High-temperature 60 V, 2 A Schottky barrier rectifier 11 October 2012

**Product data sheet** 

#### **Product profile** 1.

### 1.1 General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD128 small and flat lead Surface-Mounted Device (SMD) plastic package.

### 1.2 Features and benefits

- Average forward current:  $I_{F(AV)} \le 2 A$ •
- Reverse voltage:  $V_R \le 60 V$ •
- Low forward voltage
- . High power capability due to clip-bonding technology
- Small and flat lead SMD plastic package
- AEC-Q101 qualified •
- High temperature T<sub>i</sub> ≤ 175 °C

### 1.3 Applications

- Low voltage rectification •
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Reverse polarity protection

### 1.4 Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>F</sub>	forward current	T <sub>sp</sub> = 165 °C		-	-	2.8	А
I <sub>F(AV)</sub> average forward current		δ = 0.5 ; f = 20 kHz; T <sub>amb</sub> ≤ 120 °C; square wave	[1]	-	-	2	А
		δ = 0.5 ; f = 20 kHz; T <sub>sp</sub> ≤ 170 °C; square wave		-	-	2	А
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	-	60	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 2 A; T <sub>j</sub> = 25 °C		-	460	530	mV
I <sub>R</sub>	reverse current	$T_{j} = 25 \ ^{\circ}\text{C}; \ V_{\text{R}} = 60 \ \text{V}; \ t_{p} \leq 300 \ \mu\text{s}; \\ \delta \leq 0.02 \ ; \ \text{pulsed}$		-	60	150	μA







Scan or click this QR code to view the latest information for this product

## PMEG6020ETP

#### High-temperature 60 V, 2 A Schottky barrier rectifier

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t <sub>rr</sub>	reverse recovery time	$I_R$ = 0.5 A; $I_F$ = 0.5 A; $I_{R(meas)}$ = 0.1 A;	-	8.6	-	ns
		T <sub>j</sub> = 25 °C				

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al<sub>2</sub>O<sub>3</sub>, standard footprint.

### 2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode[1]		1 🛃 2
2	А	anode		sym001
			SOD128	

[1] The marking bar indicates the cathode.

### 3. Ordering information

Table 3. Ordering information					
Type number	Package				
	Name	Description	Version		
PMEG6020ETP	SOD128	plastic surface-mounted package; 2 leads	SOD128		

### 4. Marking

Table 4. Marking codes	
Type number	Marking code
PMEG6020ETP	D9

## 5. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	60	V
l <sub>F</sub>	forward current	T <sub>sp</sub> = 165 °C		-	2.8	А
I <sub>F(AV)</sub>	average forward current	δ = 0.5 ; f = 20 kHz; T <sub>amb</sub> ≤ 120 °C; square wave	[1]	-	2	A
		$\label{eq:delta} \begin{split} \delta &= 0.5 \ ; \ f = 20 \ \text{kHz}; \ \text{T}_{\text{sp}} \leq 170 \ ^{\circ}\text{C}; \\ \text{square wave} \end{split}$		-	2	A
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8 ms; $T_{j(init)}$ = 25 °C; square wave		-	50	A
PMEG6020ETP	All informa	tion provided in this document is subject to legal disclaimers.		©NX	P B.V. 2012. A	Il rights reserve

Product data sheet

11 October 2012

## PMEG6020ETP

#### High-temperature 60 V, 2 A Schottky barrier rectifier

Symbol	Parameter	Conditions		Min	Max	Unit
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[2]	-	750	mW
		[3]	-	1250	mW	
		[1]	-	2500	mW	
Тj	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

[1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al<sub>2</sub>O<sub>3</sub>, standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

### 6. Thermal characteristics

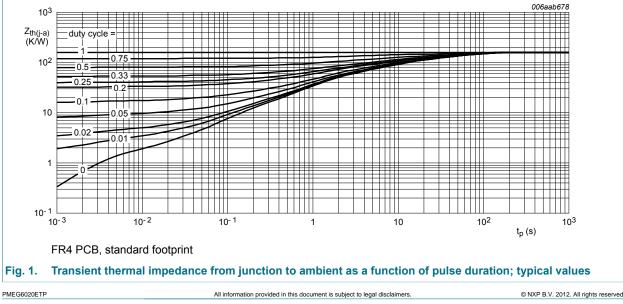
Table 6. Thermal characteristics							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
ung-a)	thermal resistance from junction to ambient	-	[1][2]	-	-	200	K/W
			[1][3]	-	-	120	K/W
			[1][4]	-	-	60	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[5]	-	-	12	K/W

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.

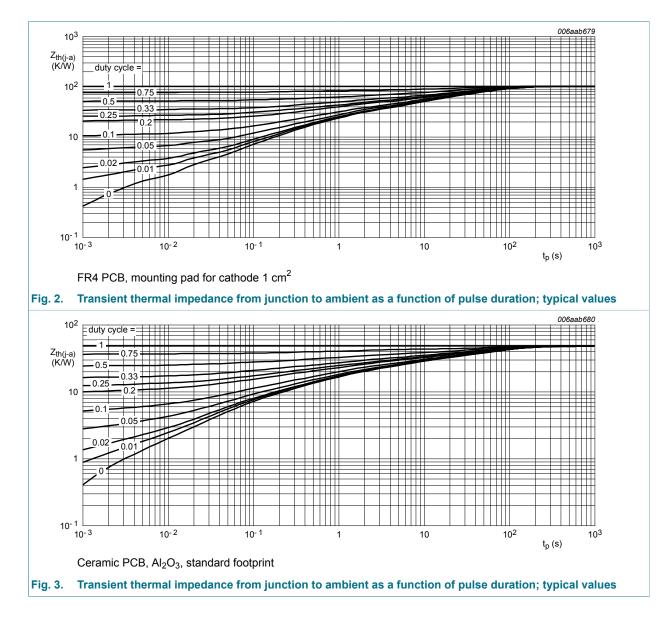
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

- [4] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [5] Soldering point of cathode tab.



#### High-temperature 60 V, 2 A Schottky barrier rectifier



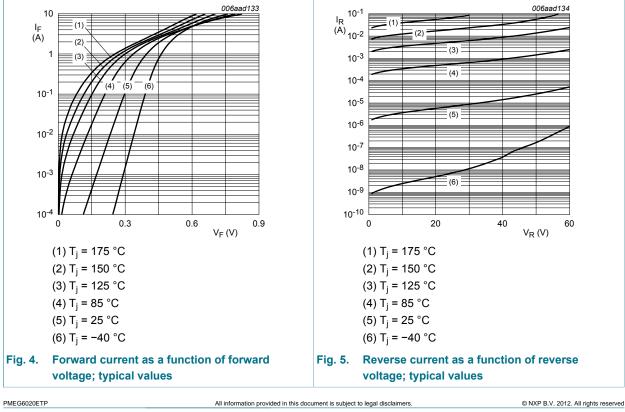
### 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>F</sub> forward voltage	I <sub>F</sub> = 0.1 A; T <sub>j</sub> = 25 °C	-	300	340	mV	
	I <sub>F</sub> = 0.5 A; T <sub>j</sub> = 25 °C	-	360	420	mV	
		I <sub>F</sub> = 1 A; T <sub>j</sub> = 25 °C	-	400	460	mV
	I <sub>F</sub> = 1.5 A; T <sub>j</sub> = 25 °C	-	430	500	mV	
		I <sub>F</sub> = 2 A; T <sub>j</sub> = 25 °C	-	460	530	mV
		I <sub>F</sub> = 2 A; T <sub>j</sub> = -40 °C	-	500	590	mV
PMEG6020ETP		All information provided in this document is subject to legal disclaim	ners.	© N	XP B.V. 2012.	All rights rese

## PMEG6020ETP

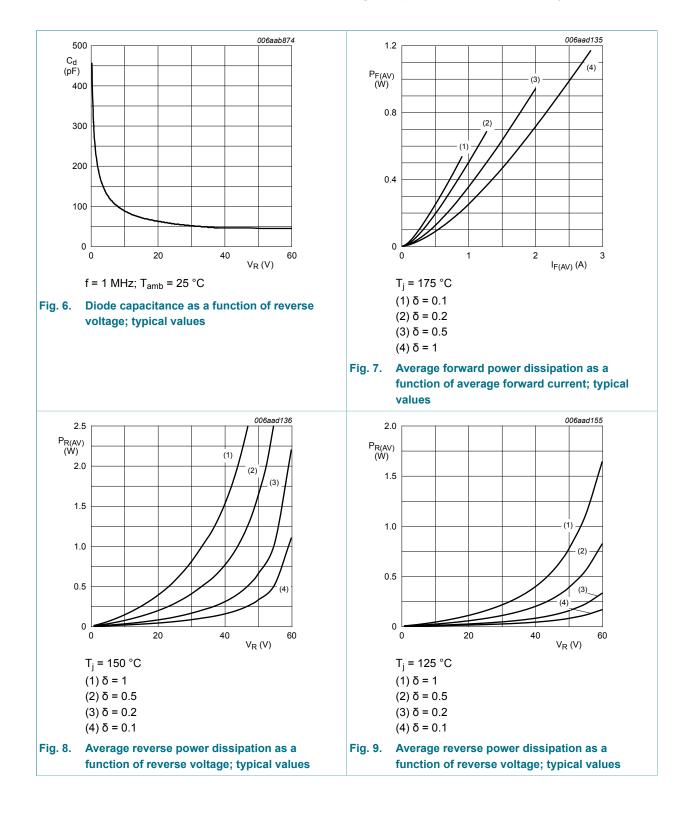
#### High-temperature 60 V, 2 A Schottky barrier rectifier

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
		I <sub>F</sub> = 2 A; T <sub>j</sub> = 125 °C	-	395	480	mV
		I <sub>F</sub> = 2 A; T <sub>j</sub> = 150 °C	-	380	460	mV
		I <sub>F</sub> = 2 A; T <sub>j</sub> = 175 °C	-	360	450	mV
I <sub>R</sub> reverse cu	reverse current	$V_R$ = 5 V; T <sub>j</sub> = 25 °C; t <sub>p</sub> ≤ 300 µs; $\delta \le 0.02$ ; pulsed	-	2.5	-	μA
		$V_R$ = 10 V; T <sub>j</sub> = 25 °C; t <sub>p</sub> ≤ 300 µs; $\overline{\delta}$ ≤ 0.02 ; pulsed	-	3.5	-	μA
		$V_R$ = 60 V; T <sub>j</sub> = 25 °C; t <sub>p</sub> ≤ 300 µs; $\delta \le 0.02$ ; pulsed	-	60	150	μA
		$V_R$ = 60 V; T <sub>j</sub> = -40 °C; t <sub>p</sub> ≤ 300 µs; $\delta \le 0.02$ ; pulsed	-	0.9	15	μA
		$V_R$ = 60 V; T <sub>j</sub> = 125 °C; t <sub>p</sub> ≤ 300 µs; $\delta \le 0.02$ ; pulsed	-	27	100	mA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	240	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	80	-	pF
t <sub>rr</sub>	reverse recovery time	$I_{F} = 0.5 \text{ A}; I_{R} = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_{j} = 25 \text{ °C}$	-	8.6	-	ns
V <sub>FRM</sub>	peak forward recovery voltage	$I_F$ = 1 A; $dI_F/dt$ = 40 A/µs; $T_j$ = 25 °C	-	401	-	mV



## PMEG6020ETP

#### High-temperature 60 V, 2 A Schottky barrier rectifier

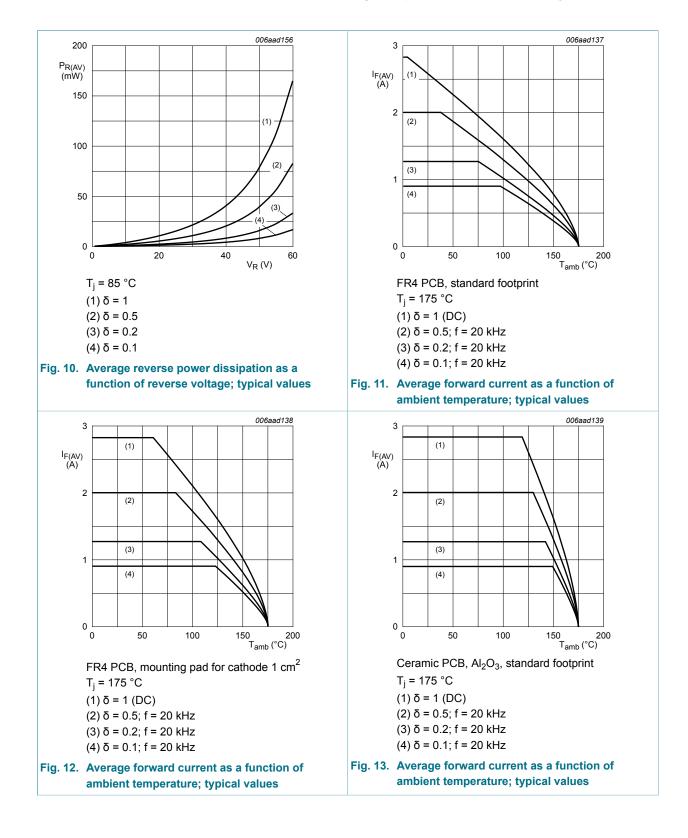


PMEG6020ETP

All information provided in this document is subject to legal disclaimers.

## PMEG6020ETP

#### High-temperature 60 V, 2 A Schottky barrier rectifier

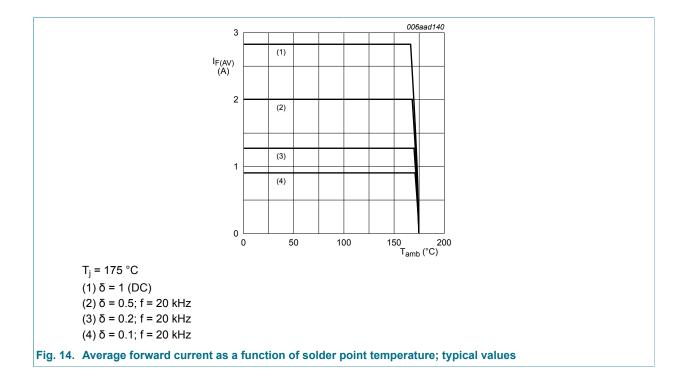


PMEG6020ETP

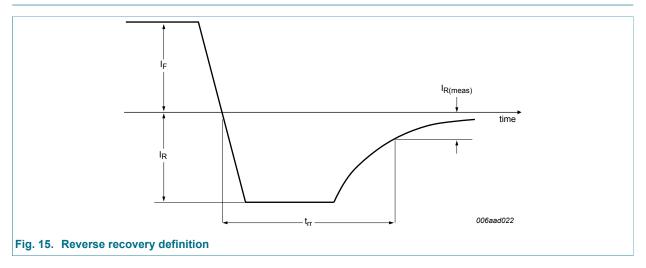
All information provided in this document is subject to legal disclaimers.

## PMEG6020ETP

#### High-temperature 60 V, 2 A Schottky barrier rectifier



### 8. Test information



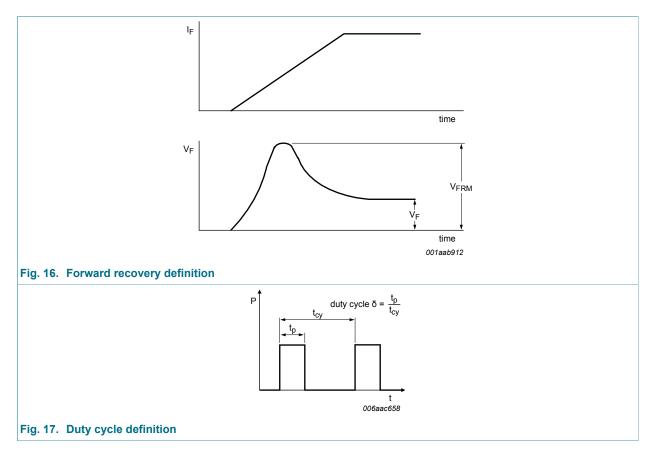
PMEG6020ETP

All information provided in this document is subject to legal disclaimers.

8/13

## PMEG6020ETP

#### High-temperature 60 V, 2 A Schottky barrier rectifier



The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

### 8.1 Quality information

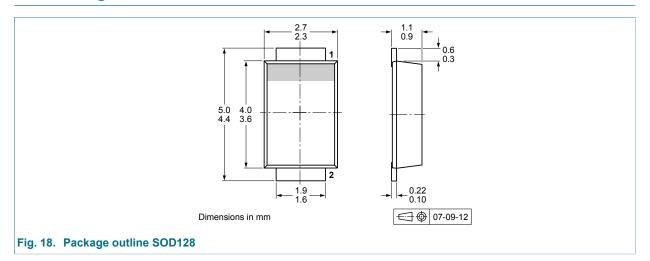
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

PMEG6020ETP

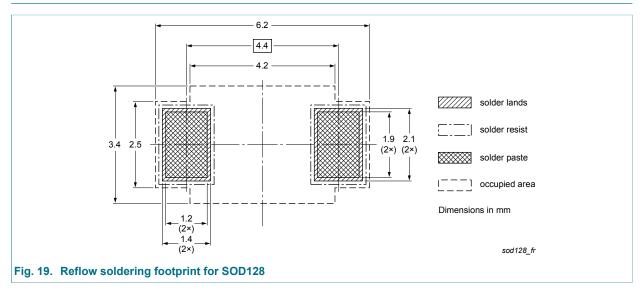
9/13

High-temperature 60 V, 2 A Schottky barrier rectifier

## 9. Package outline



## 10. Soldering



## 11. Revision history

Table 8. Revision history					
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes	
PMEG6020ETP v.1	20121011	Product data sheet	-	-	

PMEG6020ETP

All information provided in this document is subject to legal disclaimers.

10/13

#### High-temperature 60 V, 2 A Schottky barrier rectifier

### 12. Legal information

#### 12.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <u>http://www.nxp.com</u>.

#### 12.2 Definitions

Preview — The document is a preview version only. The document is still subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

### 12.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors. In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use in automotive applications — This NXP Semiconductors product has been qualified for use in automotive applications. Unless otherwise agreed in writing, the product is not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <u>http://www.nxp.com/profile/terms</u>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

PMEG6020ETP
-------------

#### High-temperature 60 V, 2 A Schottky barrier rectifier

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

### 12.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

Adelante, Bitport, Bitsound, CoolFlux, CoReUse, DESFire, EZ-HV, FabKey, GreenChip, HiPerSmart, HITAG, I<sup>2</sup>C-bus logo, ICODE, I-CODE, ITEC, Labelution, MIFARE, MIFARE Plus, MIFARE Ultralight, MoReUse, QLPAK, Silicon Tuner, SiliconMAX, SmartXA, STARplug, TOPFET, TrenchMOS, TriMedia and UCODE — are trademarks of NXP B.V.

HD Radio and HD Radio logo — are trademarks of iBiquity Digital Corporation.

PMEG6020ETP

#### High-temperature 60 V, 2 A Schottky barrier rectifier

### **13. Contents**

1	Product profile1
1.1	General description1
1.2	Features and benefits1
1.3	Applications1
1.4	Quick reference data1
2	Pinning information2
3	Ordering information2
4	Marking2
5	Limiting values2
6	Thermal characteristics3
7	Characteristics4
8	Test information8
8.1	Quality information
9	Package outline 10
10	Soldering 10
11	Revision history10
12	Legal information11
12.1	Data sheet status 11
12.2	Definitions11
12.3	Disclaimers11
12.4	Trademarks 12

### © NXP B.V. 2012. All rights reserved

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com Date of release: 11 October 2012

PMEG6020ETP